

HD74AC00

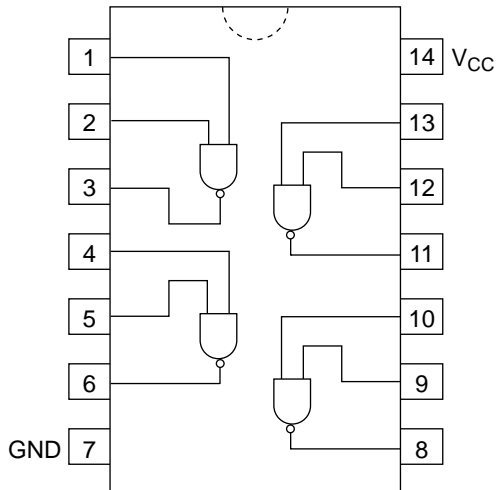
Quad 2-Input NAND Gate

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Feature

- Outputs Source/Sink 24 mA

Pin Arrangement



(Top view)

DC Characteristics (unless otherwise specified)

Item	Symbol	Max	Unit	Condition
Maximum quiescent supply current	I_{CC}	40	μA	$V_{IN} = V_{CC}$ or ground, $V_{CC} = 5.5 \text{ V}$, $T_a = \text{Worst case}$
Maximum quiescent supply current	I_{CC}	4.0	μA	$V_{IN} = V_{CC}$ or ground, $V_{CC} = 5.5 \text{ V}$, $T_a = 25^\circ\text{C}$

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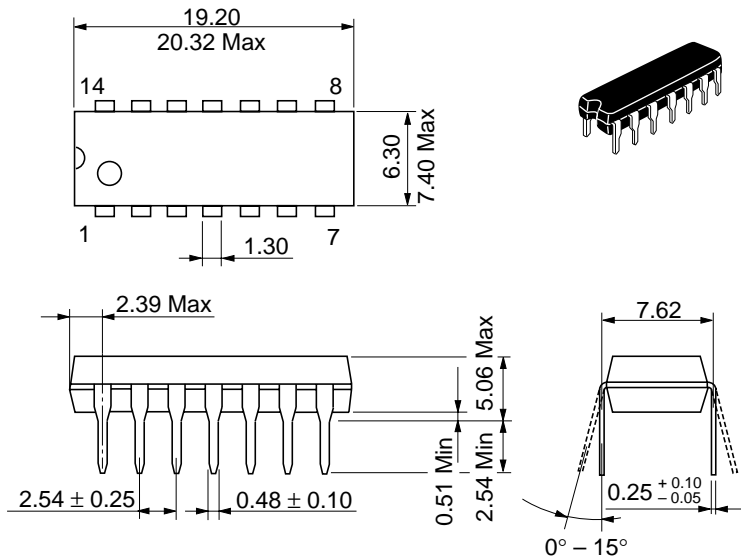
AC Characteristics

Item	Symbol	V _{CC} (V) ^{*1}	Ta = +25°C C _L = 50 pF			Ta = -40°C to +85°C C _L = 50 pF		Unit
			Min	Typ	Max	Min	Max	
Propagation delay	t _{PLH}	3.3	1.0	7.0	9.5	1.0	10.0	ns
		5.0	1.0	6.0	8.0	1.0	8.5	
Propagation delay	t _{PHL}	3.3	1.0	5.5	8.0	1.0	8.5	ns
		5.0	1.0	4.5	6.5	1.0	7.5	

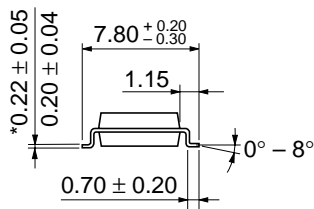
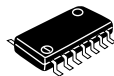
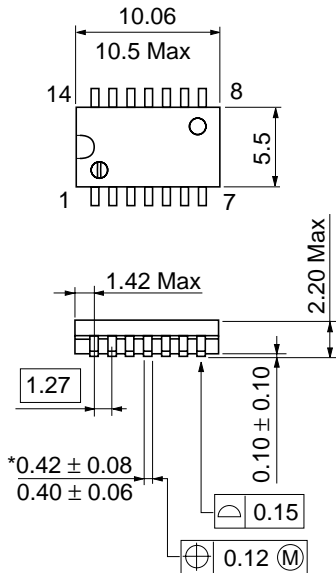
Note: 1. Voltage Range 3.3 is 3.3 V ± 0.3 V
Voltage Range 5.0 is 5.0 V ± 0.5 V

Capacitance

Item	Symbol	Typ	Unit	Condition
Input capacitance	C _{IN}	4.5	pF	V _{CC} = 5.5 V
Power dissipation capacitance	C _{PD}	30.0	pF	V _{CC} = 5.0 V

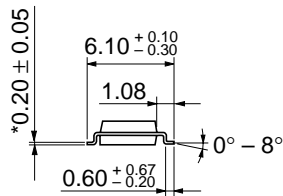
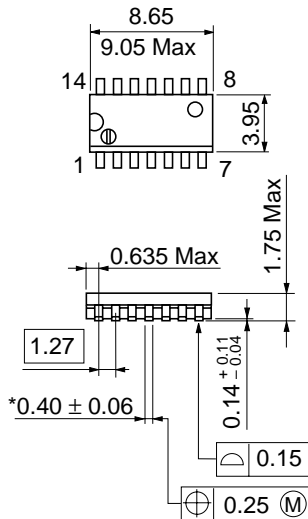


Hitachi Code	DP-14
JEDEC	Conforms
EIAJ	Conforms
Weight (reference value)	0.97 g

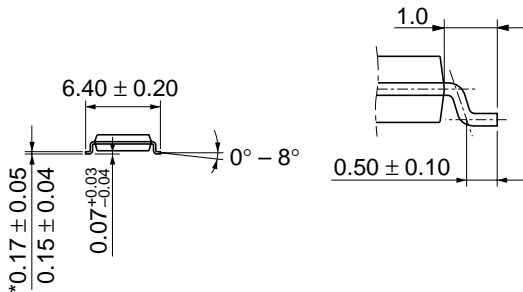
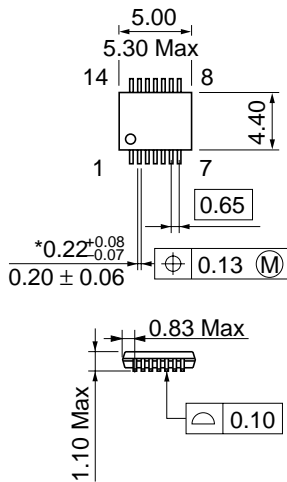


*Dimension including the plating thickness
Base material dimension

Hitachi Code	FP-14DA
JEDEC	—
EIAJ	Conforms
Weight (reference value)	0.23 g



Hitachi Code	FP-14DN
JEDEC	Conforms
EIAJ	Conforms
Weight (reference value)	0.13 g



*Dimension including the plating thickness
Base material dimension

Hitachi Code	TTP-14D
JEDEC	—
EIAJ	—
Weight (reference value)	0.05 g

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